



**RELIABILITY DATA**  
**LT685 / LT6650 / LT6700**

**6/17/04**

**• OPERATING LIFE TEST**

PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE CODE	NEWEST DATE CODE	K DEVICE HOURS <sup>(1)</sup> AT +125°C	NUMBER OF FAILURES <sup>(2)</sup>
HERMETIC	57	8805	8805	379.21	0
PLASTIC DIP	199	9316	9316	1,916.77	0
SOIC/SOT/MSOP	153	0337	0421	153.00	0
	409			2,448.98	0

**• PRESSURE COOKER TEST AT 15 PSIG, +121°C**

PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE CODE	NEWEST DATE CODE	K DEVICE HOURS	NUMBER OF FAILURES
PLASTIC DIP	150	9410	0138	3.60	0
SOIC/SOT/MSOP	50	0320	0320	1.20	0
	200			4.80	0

**• TEMP CYCLE FROM -65°C to +150°C**

PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE CODE	NEWEST DATE CODE	K DEVICE CYCLES	NUMBER OF FAILURES
PLASTIC DIP	100	9410	0138	10.00	0
SOIC/SOT/MSOP	50	0320	0320	5.00	0
	150			15.00	0

**• THERMAL SHOCK FROM -65°C to +150°C**

PACKAGE TYPE	SAMPLE SIZE	OLDEST DATE CODE	NEWEST DATE CODE	K DEVICE CYCLES	NUMBER OF FAILURES
PLASTIC DIP	50	9512	9512	5.00	0
SOIC/SOT/MSOP	50	0320	0320	5.00	0
	100			10.00	0

(1) Assumes Activation Energy = 1.0 Electron Volts  
 (2) Failure Rate Equivalent to +55°C, 60% Confidence Level = 0.75 FITS  
 (3) Mean Time Between Failures in Years = 152,103  
 Note: 1 FIT = 1 Failure in One Billion Hours.